

Vishay Siliconix

Dual P-Channel 20-V (D-S) MOSFET

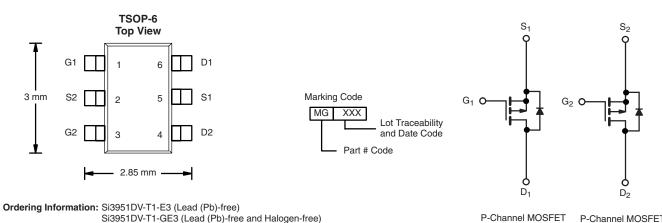
PRODUCT SUMMARY						
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^a	Q _g (Typ.)			
- 20	0.115 at V _{GS} = - 4.5 V	- 2.7	3.2 nC			
	0.205 at V_{GS} = - 2.5 V	- 2.0	3.2 110			

FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET[®] Power MOSFET
- **PWM Optimized** •
- 100 % R_g Tested
- Compliant to RoHS Directive 2002/95/EC



FREE Available



P-Channel MOSFET

P-Channel MOSFET

ABSOLUTE MAXIMUM RATIN	GS T _A = 25 °C,	unless othe	erwise noted		
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	- 20	V	
Gate-Source Voltage		V _{GS}	± 12	v	
	T _C = 25 °C	- I _D -	- 2.7		
Continuous Drain Current (T _{.1} = 150 °C)	T _C = 70 °C		- 2.2		
	T _A = 25 °C		- 2.5 ^{b, c}		
	T _A = 70 °C		- 2.0 ^{b, c}	A	
Pulsed Drain Current		I _{DM}	10		
Continuous Source-Drain Diode Current	T _C = 25 °C		- 1.67		
	T _A = 25 °C	ا _S	- 0.95 ^{b, c}		
Maximum Power Dissipation ^a	T _C = 25 °C	P _D	2.0		
	T _C = 70 °C		1.3	w	
	T _A = 25 °C	טי	1.14 ^{b, c}	~~~~~	
	T _A = 70 °C]	0.73 ^{b, c}		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	٥°	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{b, d}	t ≤ 5 s	R _{thJA}	93	110	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	75	90	0/10	

Notes:

a. Based on T_C = 25 °C. b. Surface Mounted on 1" x 1" FR4 board.

c. t = 5 s.

d. Maximum under Steady State conditions is 130 °C/W.

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static					•	•	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = -250 \mu A$	- 20			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = - 250 μA		- 16.7		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	η - 200 μΑ		2.1		mv/ c	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$	- 0.6		- 1.5	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 12 V$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = - 20 V, V _{GS} = 0 V			- 1		
		V_{DS} = - 20 V, V_{GS} = 0 V, T_{J} = 55 °C			- 10	- μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge -5 V, V_{GS} = -4.5 V$	- 10			Α	
Drain-Source On-State Resistance ^a		V _{GS} = - 4.5 V, I _D = - 2.5 A		0.092	0.115		
	R _{DS(on)}	V _{GS} = - 2.5 V, I _D = - 1.8 A		0.164	0.205	Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 10 V, I _D = - 2.5 A		5.5		S	
Dynamic ^b				<u>1</u>	I	1	
Input Capacitance	C _{iss}			250		pF	
Output Capacitance	C _{oss}	V _{DS} = - 10 V, V _{GS} = 0 V, f = 1 MHz		80			
Reverse Transfer Capacitance	C _{rss}			55			
T + 1 0 + 01	Qg	V_{DS} = - 10 V, V_{GS} = - 5.0 V, I_{D} = - 2.5 A		3.4	5.1		
Total Gate Charge				3.2	5	nC	
Gate-Source Charge	Q _{gs}	V_{DS} = - 10 V, V_{GS} = - 4.5 V, I_D = - 2.5 A		0.5			
Gate-Drain Charge	Q _{gd}			1.4			
Gate Resistance	Rg	f = 1 MHz		8.5	13	Ω	
Turn-On Delay Time	t _{d(on)}			9	14		
Rise Time	t _r	V_{DD} = - 10 V, R_L = 5 Ω		30	45	ns	
Turn-Off Delay Time	t _{d(off)}	$\text{I}_\text{D}\cong$ - 2 A, V_GEN = - 4.5 V, R_g = 1 Ω		32	48		
Fall Time	t _f			16	24		
Drain-Source Body Diode Characteristic	s					1	
Continuous Source-Drain Diode Current	۱ _S	T _C = 25 °C			- 1.7	А	
Pulse Diode Forward Current	I _{SM}				- 10		
Body Diode Voltage	V _{SD}	I _S = - 2.0 A		- 0.8	- 1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			17	26	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	L = 2.0.4 dl/dt = 100.4/up T = 25.00		5	8	nC	
Reverse Recovery Fall Time	ta	I _F = - 2.0 A, dl/dt = 100 A/μs, T _J = 25 °C		14			
Reverse Recovery Rise Time	t _b			3		ns	

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %

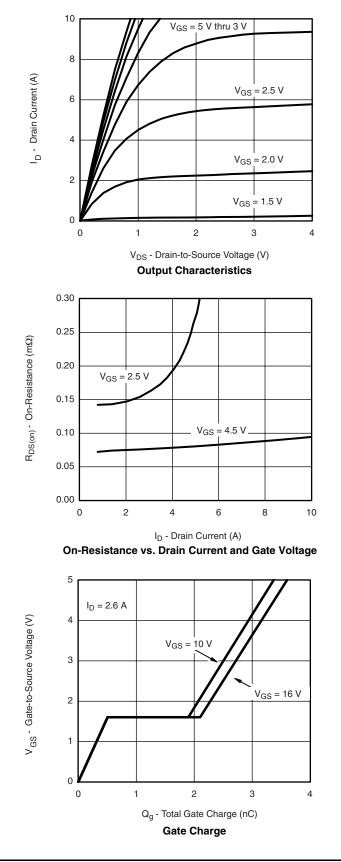
b. Guaranteed by design, not subject to production testing.

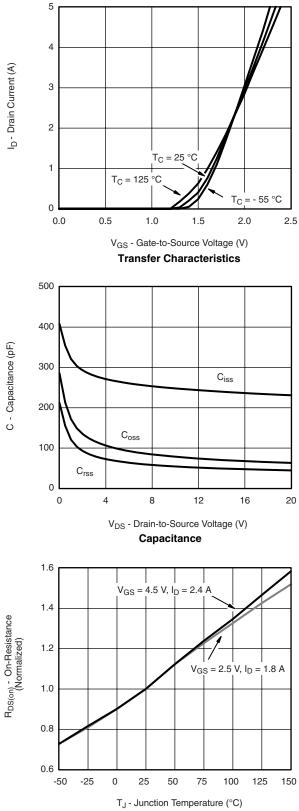
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

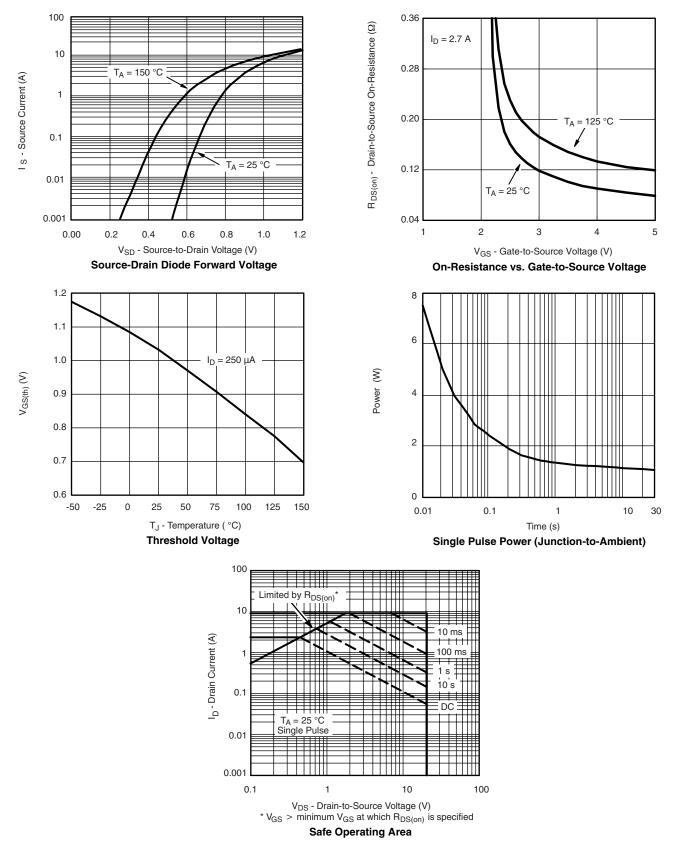


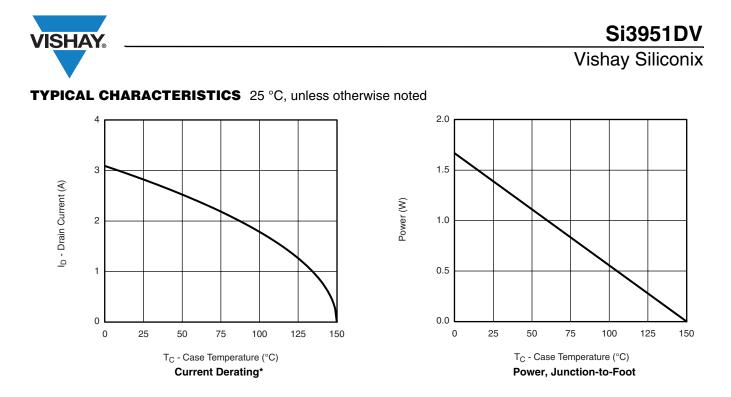


On-Resistance vs. Junction Temperature

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



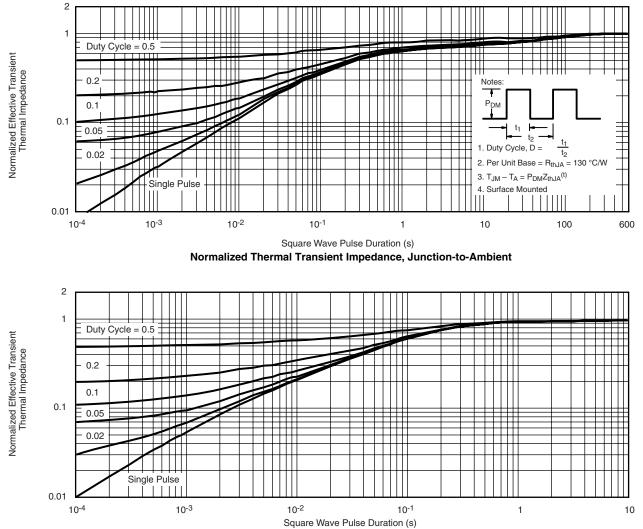


* The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?73700.



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